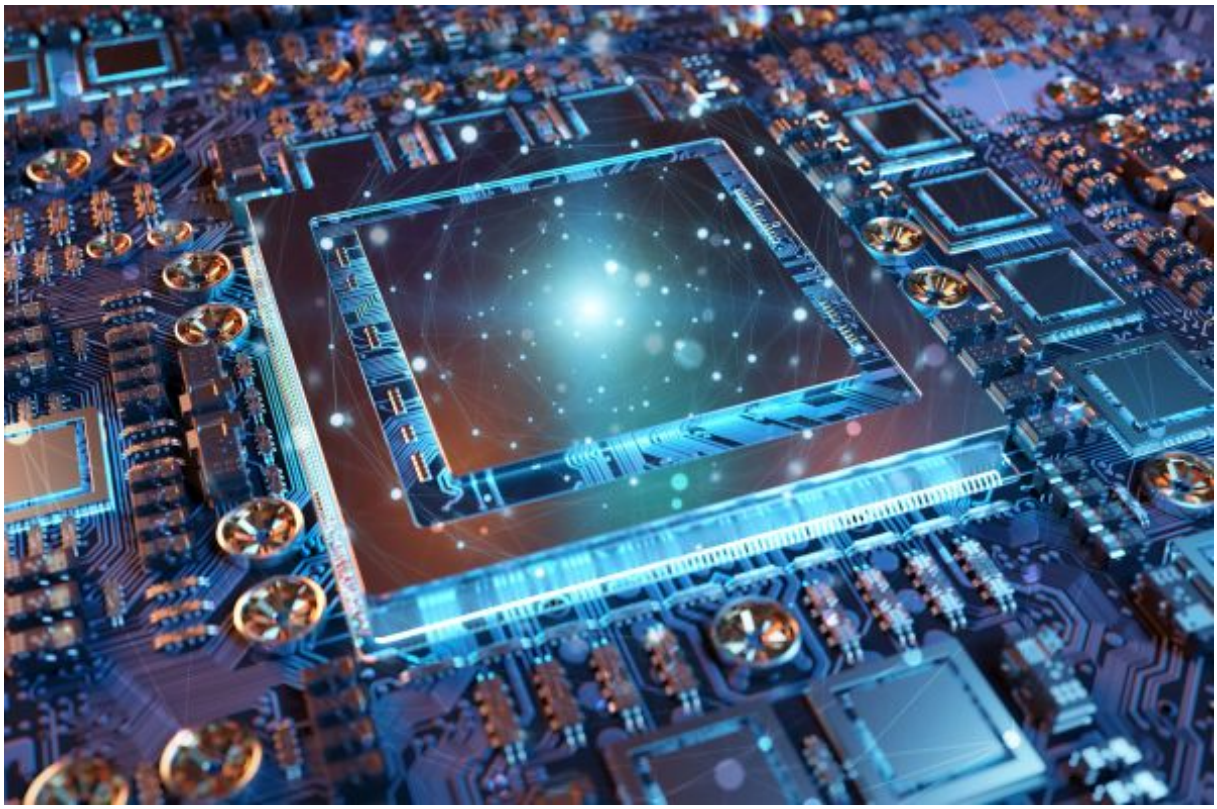


CLP Day: Photonic Chips for Information and Quantum Applications

April 19, 2024
09:30 to 15:00
ICFO Auditorium

The **Corporate Liaison Program (CLP) Day** is a periodic meeting where ICFOnians, representatives of international platforms, multinational corporations, local business representatives and researchers of other institutions have the opportunity to interact with experts from around the world in a particular sector to review the latest advances in photonic technologies while focusing on the generation of joint research projects.